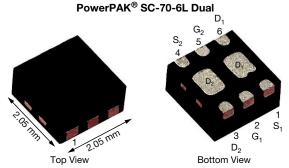
**HALOGEN** 

FREE



www.vishay.com

# **Dual P-Channel 30 V (D-S) MOSFET**



Marking code: DN

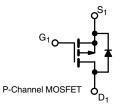
PRODUCT SUMMARY									
V <sub>DS</sub> (V)	-30								
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -10 \text{ V}$	0.064								
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -4.5 \text{ V}$	0.078								
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -2.5 \text{ V}$	0.120								
Q <sub>g</sub> typ. (nC)	6.6								
I <sub>D</sub> (A) <sup>a</sup>	-4.5								
Configuration	Dual								

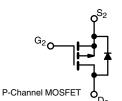
#### **FEATURES**

- TrenchFET® Gen III power MOSFET
- Thermally enhanced PowerPAK® SC-70 package
  - Small footprint area
  - Low on-resistance
- 100 % R<sub>q</sub> tested
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

#### **APPLICATIONS**

- Load switch and battery management for smart phones, tablet PCs, and portable media players
- · Fast battery charging





ORDERING INFORMATION						
Package	PowerPAK SC-70					
Lead (Pb)-free and halogen-free	SiA929DJ-T1-GE3					

<b>ABSOLUTE MAXIMUM RATINGS</b>	$(T_A = 25  ^{\circ}C, \text{ unless})$	otherwise note	ed)			
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage		$V_{DS}$	-30	V		
Gate-source voltage		V <sub>GS</sub>	± 12	¬		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		-4.5 <sup>a</sup>			
	T <sub>C</sub> = 70 °C	Ι , Γ	-4.5 <sup>a</sup>			
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	-4.3 b, c			
	T <sub>A</sub> = 70 °C		-3.4 <sup>b, c</sup>	Α		
Pulsed drain current (t = 300 μs)		I <sub>DM</sub>	-15			
	T <sub>C</sub> = 25 °C		-4.5 <sup>a</sup>			
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	l <sub>S</sub>	-1.6 <sup>b, c</sup>			
	T <sub>C</sub> = 25 °C		7.8			
Manian and a single state of	T <sub>C</sub> = 70 °C		5	\A/		
Maximum power dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.9 <sup>b, c</sup>	— W		
	T <sub>A</sub> = 70 °C	1	1.2 <sup>b, c</sup>			
Operating junction and storage temperature rar	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	00			
Soldering recommendations (peak temperature		260	°C			

THERMAL RESISTANCE RATINGS									
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT				
Maximum junction-to-ambient b, f	t ≤ 5 s	R <sub>thJA</sub>	52	65	°C/W				
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	12.5	16	G/VV				

#### Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- f. Maximum under steady state conditions is 110 °C/W



# Vishay Siliconix

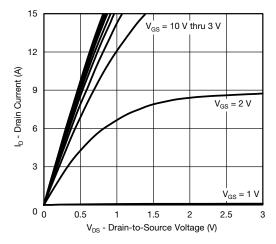
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				<u> </u>	<u> </u>		
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-30	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	AVps/Ti		-23	-	1404	
V <sub>GS(th)</sub> temperature coefficient	ΔV <sub>GS(th)</sub> /T <sub>J</sub>	$I_D = -250  \mu A$	-	1.5	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-0.6	-	-1.1	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$	-	-	± 100	nA	
Zana and a self-and distance and		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1		
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	-	-	-10	μA	
On-state drain current a	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	-10	-	-	Α	
	, ,	$V_{GS} = -10 \text{ V}, I_D = -3 \text{ A}$	-	0.052	0.064		
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -2 \text{ A}$	-	0.062	0.078	Ω	
	, ,	$V_{GS} = -2.5 \text{ V}, I_D = -1 \text{ A}$	-	0.090	0.120		
Forward transconductance a	g <sub>fs</sub>	$V_{DS} = -15 \text{ V}, I_D = -3 \text{ A}$	-	10	-	S	
Dynamic <sup>b</sup>	<u> </u>			•		l	
Input capacitance	C <sub>iss</sub>		-	575	-	pF	
Output capacitance	Coss	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	=.	60	-		
Reverse transfer capacitance	C <sub>rss</sub>		=.	51	-		
		$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -4.3 \text{ A}$	-	14	21	nC	
Total gate charge	$Q_g$		_	6.6	10		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -4.3 \text{ A}$	_	1.2	-		
Gate-drain charge	Q <sub>ad</sub>		-	1.9	-		
Gate resistance	R <sub>a</sub>	f = 1 MHz	1.1	5.5	11	Ω	
Turn-on delay time	t <sub>d(on)</sub>		_	15	30		
Rise time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, R_1 = 4.4 \Omega,$	_	18	35		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -3.4 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	_	22	40	- ns	
Fall time	t <sub>f</sub>		_	10	20		
Turn-on delay time	t <sub>d(on)</sub>		_	5	10		
Rise time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, R_1 = 4.4 \Omega,$	-	10	20		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -3.4 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	_	22	40		
Fall time	t <sub>f</sub>	•	-	10	20		
<b>Drain-Source Body Diode Characterist</b>				l		ı	
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	_	-4.5		
Pulse diode forward current	I <sub>SM</sub>		-	-	-15	Α	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -3.4 A, V <sub>GS</sub> = 0 V	-	-0.89	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>	0 - 7 00 -	_	20	40	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = -3.4 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$	-	10	20	nC	
Reverse recovery fall time	t <sub>a</sub>	$T_{\rm J} = 25  ^{\circ}{\rm C}$	_	9			
110 voloc 1000 voly lan tillio	٠a	v		J		ns	

#### Notes

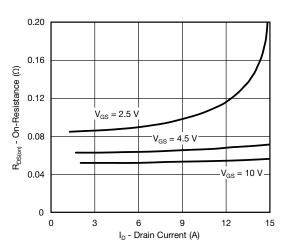
- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

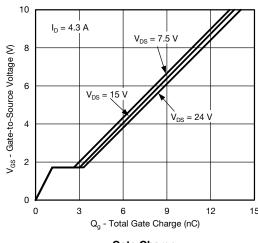




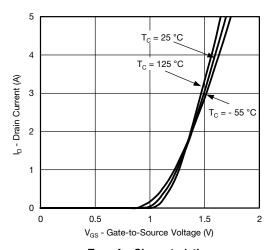
#### **Output Characteristics**



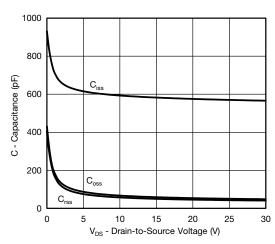
On-Resistance vs. Drain Current and Gate Voltage



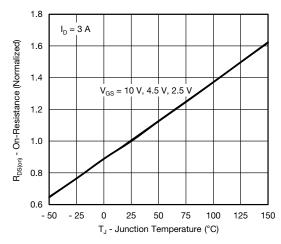
**Gate Charge** 



**Transfer Characteristics** 

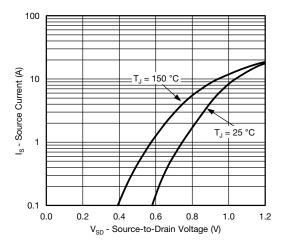


Capacitance

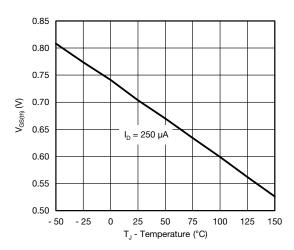


On-Resistance vs. Junction Temperature

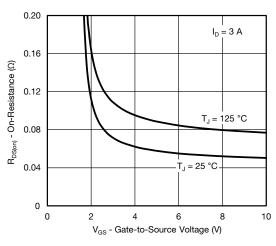




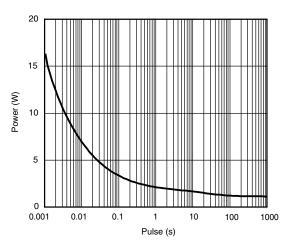
#### Source-Drain Diode Forward Voltage



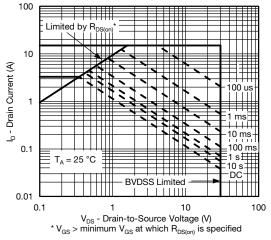
**Threshold Voltage** 



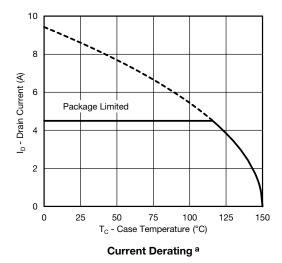
On-Resistance vs. Gate-to-Source Voltage

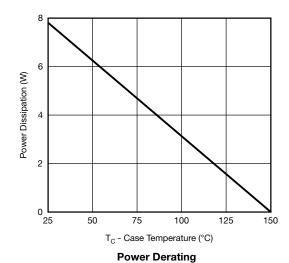


Single Pulse Power, Junction-to-Ambient





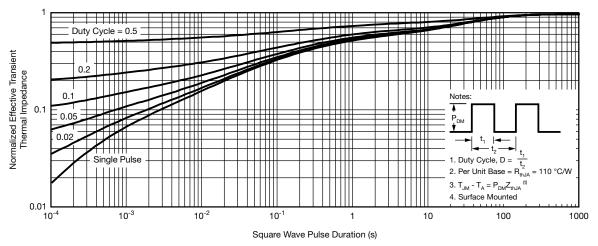




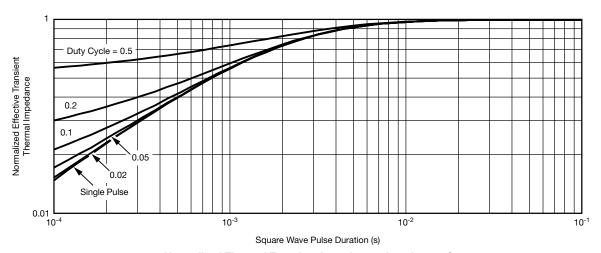
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

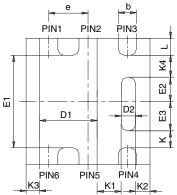
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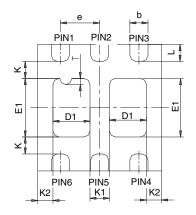




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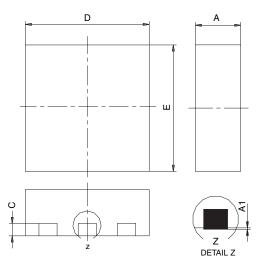
# PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
  Package outline exclusive of mold flash and metal burr
  Package outline inclusive of plating

	SINGLE PAD						DUAL PAD					
DIM	MILLIMETERS			INCHES			MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028
D2	0.135	0.235	0.335	0.005	0.009	0.013						
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041
E2	0.345	0.395	0.445	0.014	0.016	0.018						
E3	0.425	0.475	0.525	0.017	0.019	0.021						
е		0.65 BSC			0.026 BSC	;	0.65 BSC			0.026 BSC		
K		0.275 TYP			0.011 TYP		0.275 TYP			0.011 TYP		
K1		0.400 TYP		0.016 TYP		0.320 TYP			0.013 TYP			
K2		0.240 TYP		0.009 TYP		0.252 TYP			0.010 TYP			
К3		0.225 TYP		0.009 TYP					•	•		
K4		0.355 TYP		0.014 TYP		<u> </u>						
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015
T							0.05	0.10	0.15	0.002	0.004	0.006

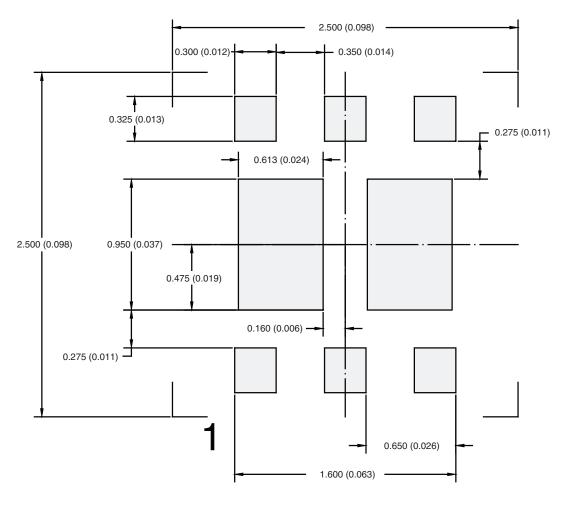
ECN: C-07431 - Rev. C, 06-Aug-07

DWG: 5934

06-Aug-07



## RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Dual



Dimensions in mm (inches)

Return to Index



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